SF 298 MASTER COPY KEEP THIS COPY FOR REPRODUCTION PURPOSES

SF 298 MASTE	R COPY KEEP THIS	COPY FOR REPRODU	CTION PURPOSES
REPORT DOCUMENTATION PAGE			. Form Approved OMB NO. 0704-0188
Public reporting burden for this collection gathering and maintaining the data need collection of information, including sugge Davis Highway, Suite 1204, Arlington, VA	of information is estimated to average 1 hour per re ed, and completing and reviewing the collection of in stions for reducing this burden, to Washington Head 22202-4302, and to the Office of Management and	Budget, Paperwork Reduction Pro	ect (0704-0188), Washington, DC 20503.
1. AGENCY USE ONLY (Leave blank) 2. REPORT DATE 3. REPORT TYPE April 2001 Final Pr		and dates covered <b>30 Jun 06</b> gress Report 7/1/96 - <del>12/31/00 -</del>	
4. TITLE AND SUBTITLE	[p		5. FUNDING NUMBERS
MOVPE Reactor for Deposition of Wide Band Gap Semiconductors			Grant Number: DAAH04-96-1-0320
6. AUTHOR(S) James H. Edgar			
7. PERFORMING ORGANIZATION NAMES(S) AND ADDRESS(ES) Kansas State University Manhattan, KS 66506-5102			8. PERFORMING ORGANIZATION REPORT NUMBER
9. SPONSORING / MONITORING	AGENCY NAME(S) AND ADDRESS(E	5)	10. SPONSORING / MONITORING AGENCY REPORT NUMBER
U.S. Army Research Offic P.O. Box 12211 Research Triangle Park, N	e By C 27709-2211		ARO Proposal Number: P-36202-RT-DPS
12a. DISTRIBUTION / AVAILABILITY STATEMENT Approved for public release; distribution unlimited.			12 b. DISTRIBUTION CODE
13. ABSTRACT (Maximum 200 wor	ds)		
A metalorganic vapor phase epitaxy reactor was constructed to study the epitaxy of $B_xGa_{1-x}N$ and $B_xAl_{1-x}N$ on 6H-SiC substrates. The solubility of boron in AlN and GaN was shown experimentally to be very low, less than 3 at%. This low solubility of boron in the group III nitrides was consistent with thermodynamic arguments based on the structure of the binary compounds involved. Adding boron to GaN increased its energy band gap up to the point of two phases forming. Unfortunately, even small additions of diborane greatly reduced the growth rate (at 1000 °C) and the crystal quality of the deposits. This furnace is continuing to be used to study the epitaxy of GaN and AlN.			
14. SUBJECT TERMS gallium nitride, GaN, aluminum nitride, AlN, boron nitride, BN, metalorganic vapor phase epitaxy, MOVPE, thin films			15. NUMBER IF PAGES 16. PRICE CODE
17. SECURITY CLASSIFICATION OR REPORT UNCLASSIFIED	18. SECURITY CLASSIFICATION OF THIS PAGE UNCLASSIFIED	19. SECURITY CLASSIFI OF ABSTRACT UNCLASSIFIE	
NSN 7540-01-280-5500	Enclosure		Standard Form 298 (Rev. 2-89) Prescribed by ANSI Std. 239-18 298-102

## MOVPE REACTOR FOR DEPOSITION OF WIDE BAND GAP SEMICONDUCTORS

#### FINAL PROGRESS REPORT

#### J.H. EDGAR

#### **APRIL 20, 2001**

## **U.S. ARMY RESEARCH OFFICE**

#### GRANT NUMBER DAAH04-96-10320

#### KANSAS STATE UNIVERSITY

#### APPROVED FOR PUBLIC RELEASE; DISTRIBUTION UNLIMITED

THE VIEWS, OPINIONS, AND/OR FINDINGS CONTAINED IN THIS REPORT ARE THOSE OF THE AUTHOR AND SHOULD NOT BE CONSTRUED AS AN OFFICIAL DEPARTMENT OF ARMY POSITION, POLICY, OR DECISION, UNLESS SO DESIGNATED BY OTHER DOCUMENTATION.

# 20010503 118

#### **Statement of the Problem Studied**

A metalorganic vapor phase epitaxy (MOVPE) reactor was built to study the synthesis of boron gallium nitride ( $B_xGa_{1-x}N$ ) and boron aluminum nitride ( $B_xAl_{1-x}N$ ) semiconductor layers. These boron containing nitride semiconductor alloys may allow greater flexibility in independently controlling the energy band and the lattice constants than is possible with other group III elements. Several advantages may be possible. By replacing approximately 5% of the Al atoms in AlN with B ( $B_{05}Al_{.95}N$ ), lattice constant matching is possible with 6H-SiC; similarly, replacing 12% of the Ga atoms in GaN with B ( $B_{0.12}Ga_{0.88}N$ ) eliminates its mismatch with AlN. This is turn may reduce the dislocation densities in these films. At low boron nitride (BN) content, these alloys may provide a superior alternative to reducing the energy band gap than the established technique of alloying GaN and AlN with indium nitride (InN), and will have greater thermal stability and smaller changes in the lattice constants leading to improved crystal quality. The effect of process conditions on the properties of the deposited films was to be established.

An additional goal was to build an MOVPE system for studying the epitaxial growth of nitride semiconductors in general. This reactor was to enhance the research competitiveness of Kansas researchers by producing materials equal to the best in the world, made with the compositions and structures of their design, to make industrial and governmental research collaboration more attractive.

# Summary of the Most Important Results

The solubility of boron in  $B_xGa_{1-x}N$  films deposited on 6H-SiC(0001) substrates at 1000 °C was quite low, 1.5 at % B. At higher boron concentrations, phase separation into a BGaN-rich phase and an amorphous, hexagonal BN phase occurred. For single phase  $B_xGa_{1-x}N$  films, the energy band gap increased with the boron concentration. The preparation of preparing boron containing nitride semiconductors proved very difficult by MOVPE. At temperatures normally employed for successful AlN and GaN epitaxy (1050 °C and 950 °C respectively), the addition of even a small amount of diborane (B/Ga ratios greater than 0.02) reduced the growthrate by a factor of 3. In addition, the surface morphology and the crystal quality of the films degraded as the boron content increased.

A thermodynamic analysis was performed to predict the vapor-solid distribution relationship, growth efficiency, and maximum single phase solubility of  $B_{1-x-y}Ga_xAl_yN$ . The large structural dissimilarity between BN and both GaN and AlN make this a highly nonideal solution. The maximum predicted boron solubilities were 1.8 at% in BGaN and 2.8 at % in BAIN at 1000 °C. The growth of BGaN is controlled by the much higher Ga partial pressure than that of B over the alloy. This large difference leads to an inhomogenous distribution of elements in the alloy films.

The MOVPE reactor was employed in studies of buffer layer growth of GaN on sapphire, the effects of 6H-SiC substrate etching on subsequently grown GaN epitaxial layers, and the epitaxial growth of cubic GaN on SiC/Si(001) substrates. This research supported collaborations with other faculty at Kansas State University and Wichita State University. This reactor

continues to be used by graduate students currently studying the electrical properties of AlN on 6H-SiC substrates with different pregrowth treatments.

#### Publications

MOCVD growth of BGaN on 6H-SiC (0001) substrates, C.H. Wei, Z.Y. Xie, J.H. Edgar, K.C. Zeng, J.Y. Lin, H.X. Jiang, J. Chaudhuri, C. Ignatiev, and D.N. Braski, J. Electron. Mater. 29 452 (2000).

Thermodynamic analysis of wurtzite  $Ga_x B_{1-x}N$  system grown by MOVPE, C.H. Wei and J.H. Edgar, J. Cryst. Growth **217** 109 (2000).

Growth and characterization of  $B_xGa_{1-x}N$  on 6H-SiC (0001) by Organometallic Vapor Phase Epitaxy, C.H. Wei, J.H. Edgar, J. Chaudhuri, and K. Ignatiev, MRS Internet J. Nitride Semicond. Res. 4S1, G3.79 (1999).

Unstable composition region in the wurtzite  $B_{1-x-y}Ga_xAl_yN$  system, C.H. Wei and J.H. Edgar, J. Cryst. Growth **208** 179 (1999).

The role of trimethygallium flow during nucleation layer deposition in the optimization of epitaxial GaN films, C.H. Wei, J.H. Edgar, K. Ignatiev, and J. Chaudhuri, Thin Solid Films. **360** 34 (2000).

MOCVD growth of cubic GaN on 3C-SiC deposted on Si(100)substrates, C.H. Wei, Z.Y. Xie, L.Y. Li, Q.M. Yu, and J.H. Edgar, J. Electron. Mater. 29 317 (2000).

Surface etching of 6H-SiC(0001) and surface morphology of the subsequently grown GaN via MOCVD, Z.Y. Xie, C.H. Wei, S.F. Chen, S.Y. Jiang, J.H. Edgar, J. Electron. Mater. 29 411 (2000).

Gaseous etching of 6H-SiC at relatively low temperatures, Z.Y. Xie, C.H. Wei, L.Y. Li, Q.M. Yu, and J.H. Edgar, J. Cryst. Growth **217** 115 (2000).

Hardness, elastic modulus, and structure of indium nitride thin films on AlN-nucleated (00.1) sapphire substrates, J.H. Edgar, C. H. Wei, D.T. Smith, T.J. Kistenmacher and W.A. Bryden, J. Mater. Sci., Electronic Mater. 8 307 (1997).

# **Reportable Inventions**

None

•

,

# Participating Personnel Earning Advanced Degrees

C.-H. Wei, Ph.D., Growth and characterization of GaB and BGaN by metal-organic chemical vapor deposition (1999).

ļ

. . .

Zhiyong Xie, Ph.D., Surface etching of 6H-SiC(0001) and its effects on growth of GaN, AlN by MOCVD, and SiC by APCVD (2000).